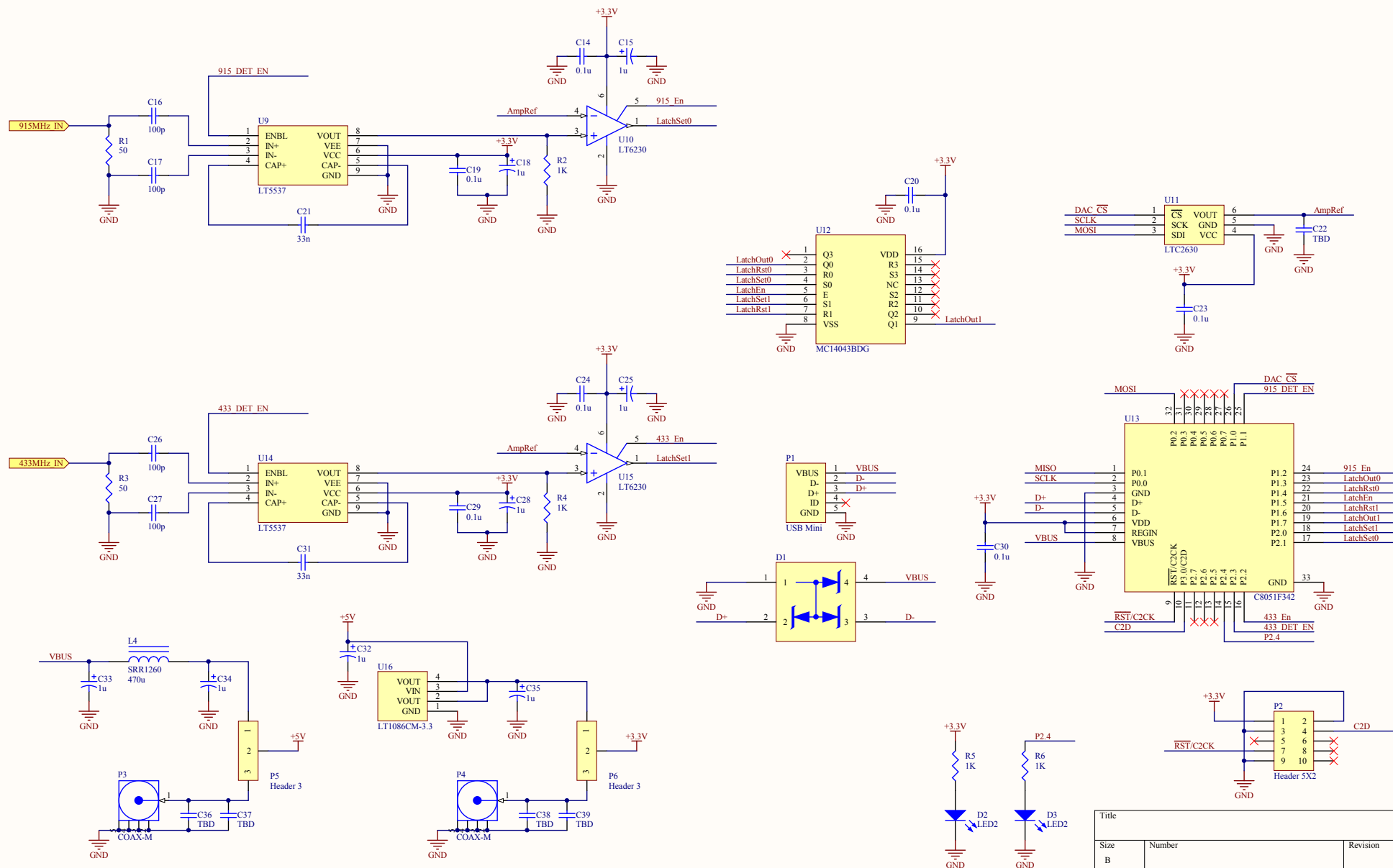
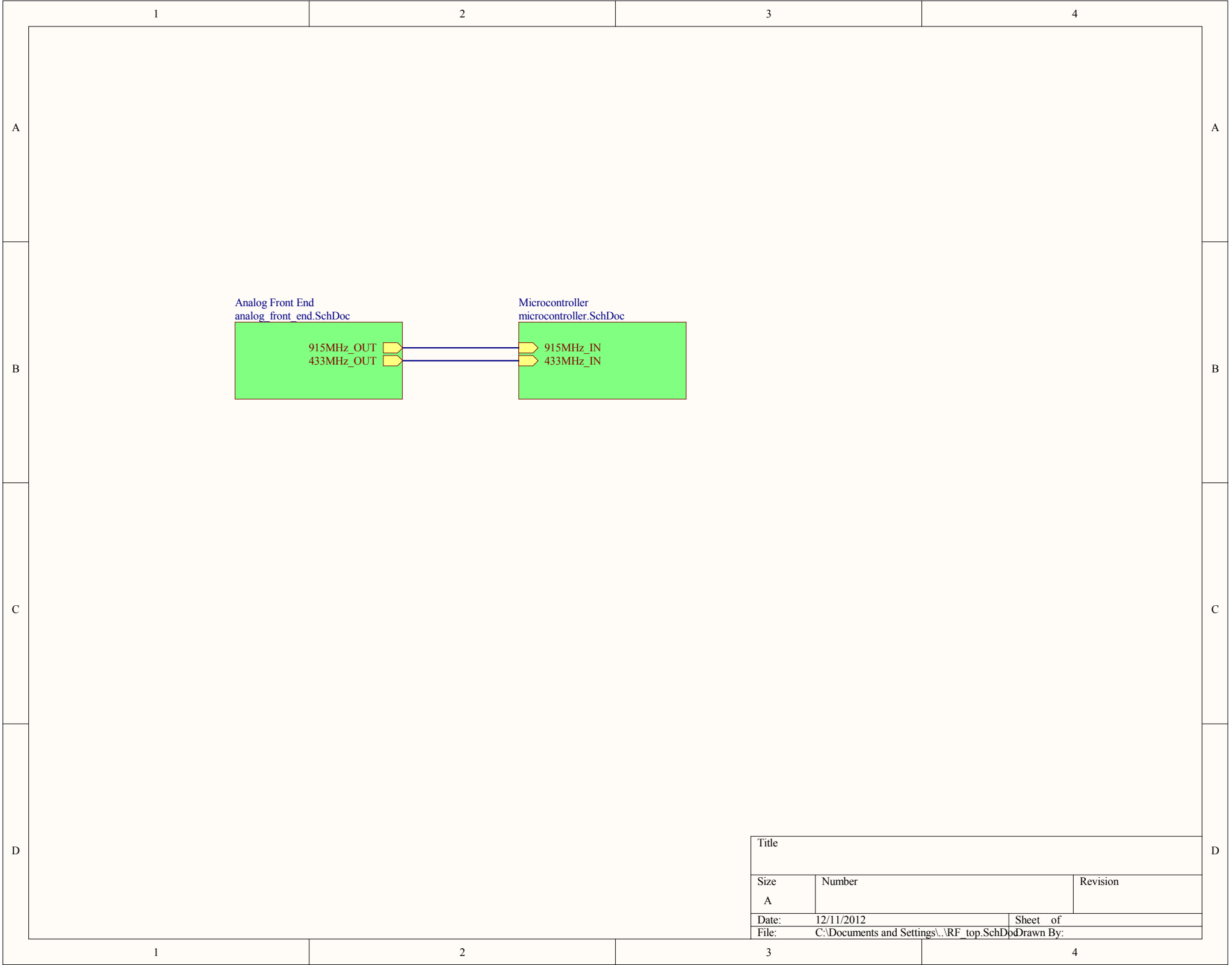


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FABRICATION NOTES

Board Notes

Size (x/y/z): 4000 mil x 4000 mil x 62 mil
Number of Holes: 505
Smallest Trace Width: 10 mil
Smallest Hole Size: 15 mil

Board Material & Stackup

Material: FR4
Finish: Pb-Free
Soldermask: Green LPI
Silkscreen: White
Copper: 1 oz. Cu
Stackup:

1. Top Layer: Routing (.gtl)
2. GND Plane: Plane - Negative (.gp1)
3. GND/Power Plane: Split Plane - Negative (.gp2)
4. Bottom Layer: Routing (.gbl)

